

APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	METHOD OF IMPROVING ALIGNMENT FOR SEMICONDUCTOR FABRICATION
<p>Application Type : regular, utility Attorney Docket Number : NTCP0030USA</p>	
<p>Correspondence address: Customer Number: 027765</p> 	
<p>Inventors Information:</p> <p><u>Inventor 1:</u></p> <p>Applicant Authority Type: Inventor Citizenship: TW Given Name: Tung-Liang Family Name: Yang Residence: City of Residence: Tao-Yuan Hsien Country of Residence: TW Address-1 of Mailing Address: 9F, No. 18-3, Chang-Le 4 St., Chung-Li City Address-2 of Mailing Address: City of Mailing Address: Tao-Yuan Hsien State of Mailing Address: Postal Code of Mailing Address: Country of Mailing Address: TW Phone: Fax: E-mail:</p> <p><u>Inventor 2:</u></p> <p>Applicant Authority Type: Inventor Citizenship: TW Given Name: Yi-Nan Family Name: Chen Residence: City of Residence: Taipei City</p>	

Country of Residence:	TW
Address-1 of Mailing Address:	No. 4, Lane 151, Chien-Min Rd., Pei-Tou
Address-2 of Mailing Address:	
City of Mailing Address:	Taipei City
State of Mailing Address:	
Postal Code of Mailing Address:	
Country of Mailing Address:	TW
Phone:	
Fax:	
E-mail:	

Attorney Information:

practitioner(s) at Customer Number:

027765



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.